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# United States Patent [19] Hayamizu

[11] **Patent Number: Des. 412,977**

[45] **Date of Patent: \*\* Aug. 17, 1999**

[54] **ELECTRONIC ENDOSCOPE PROCESSOR**

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[73] Assignee: **Asahi Kogaku Kogyo Kabushiki Kaisha**, Tokyo, Japan

[\*\*] Term: **14 Years**

[21] Appl. No.: **29/067,253**

[22] Filed: **Feb. 28, 1997**

[30] **Foreign Application Priority Data**

Sep. 4, 1996 [JP] Japan ..... 8-26422

[51] **LOC (6) Cl.** ..... **24-01**

[52] **U.S. Cl.** ..... **D24/107; D24/144; D24/186**

[58] **Field of Search** ..... D24/138, 137,  
D24/186, 107, 144; 600/160, 178, 109;  
348/65, 71, 72, 75

[56] **References Cited**

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[57] **CLAIM**

The ornamental design for an electronic endoscope processor, as shown.

**DESCRIPTION**

FIG. 1 is a perspective view of the top, front and right side of an electronic endoscope processor showing my new design;  
FIG. 2 is a front elevational view thereof;  
FIG. 3 is a rear elevational view thereof;  
FIG. 4 is a top plan view thereof;  
FIG. 5 is a right side elevational view thereof;  
FIG. 6 is a left side elevational view thereof; and,  
FIG. 7 is a bottom plan view thereof.

**1 Claim, 5 Drawing Sheets**

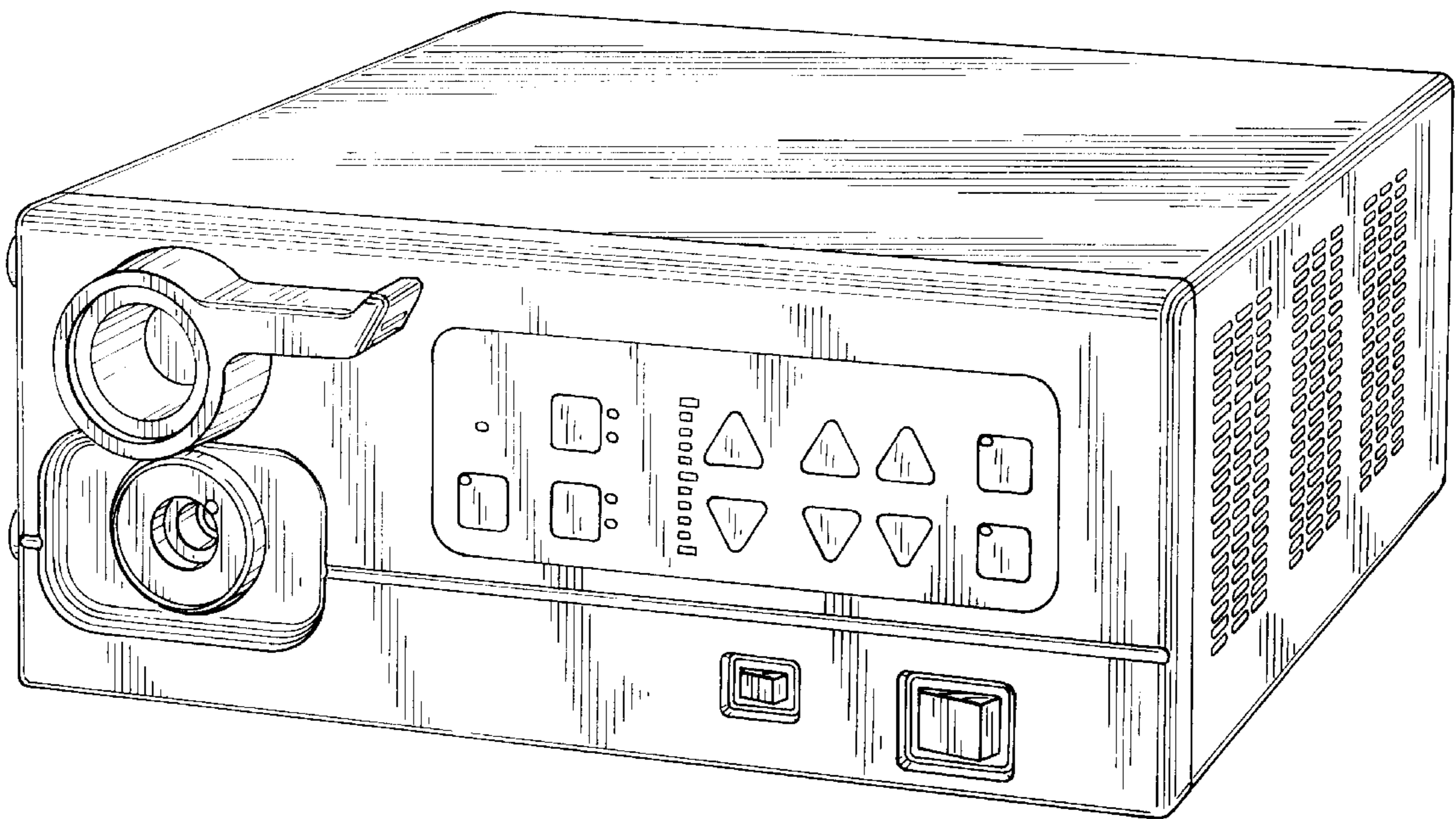


FIG. 1

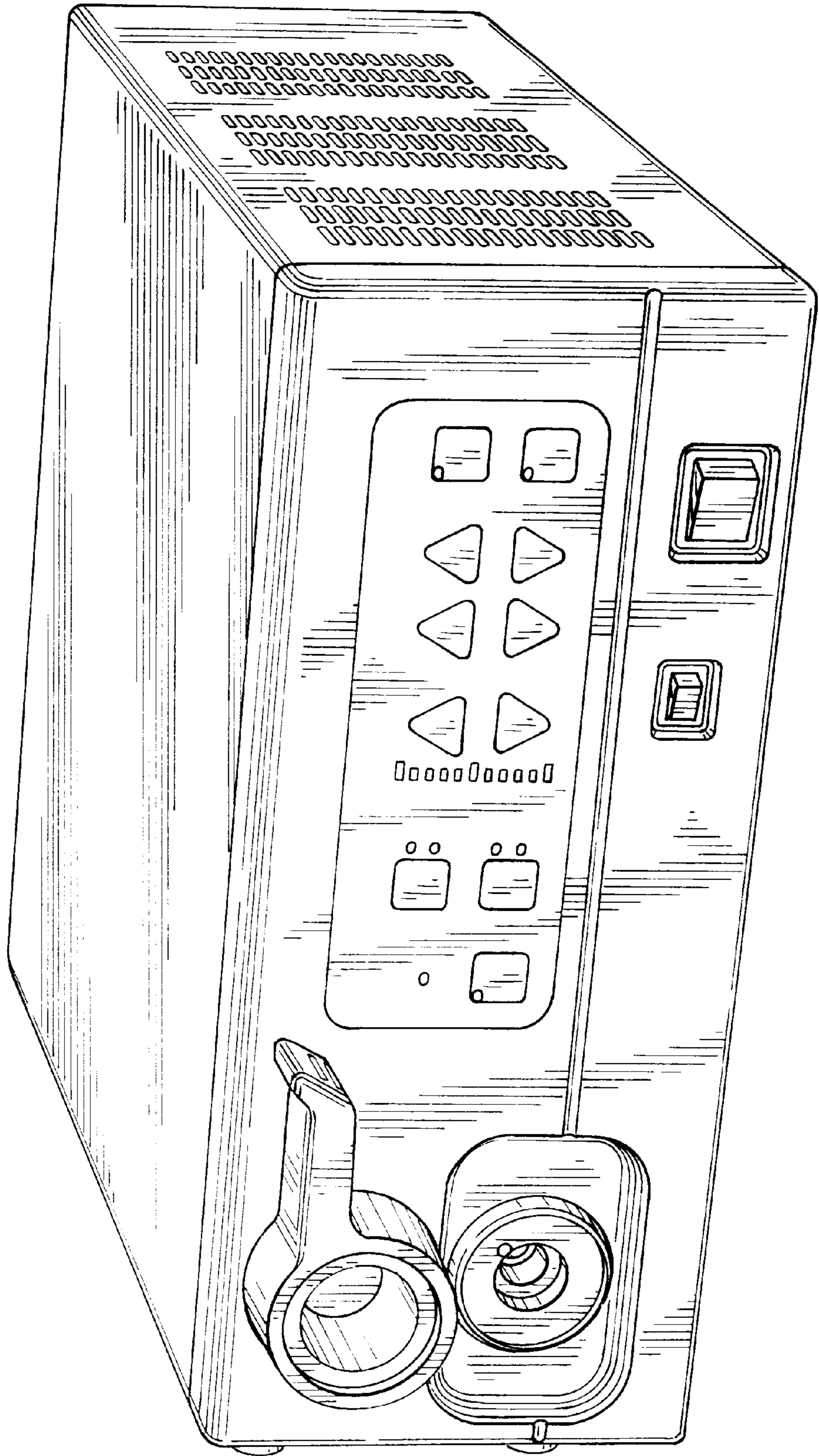


FIG. 2

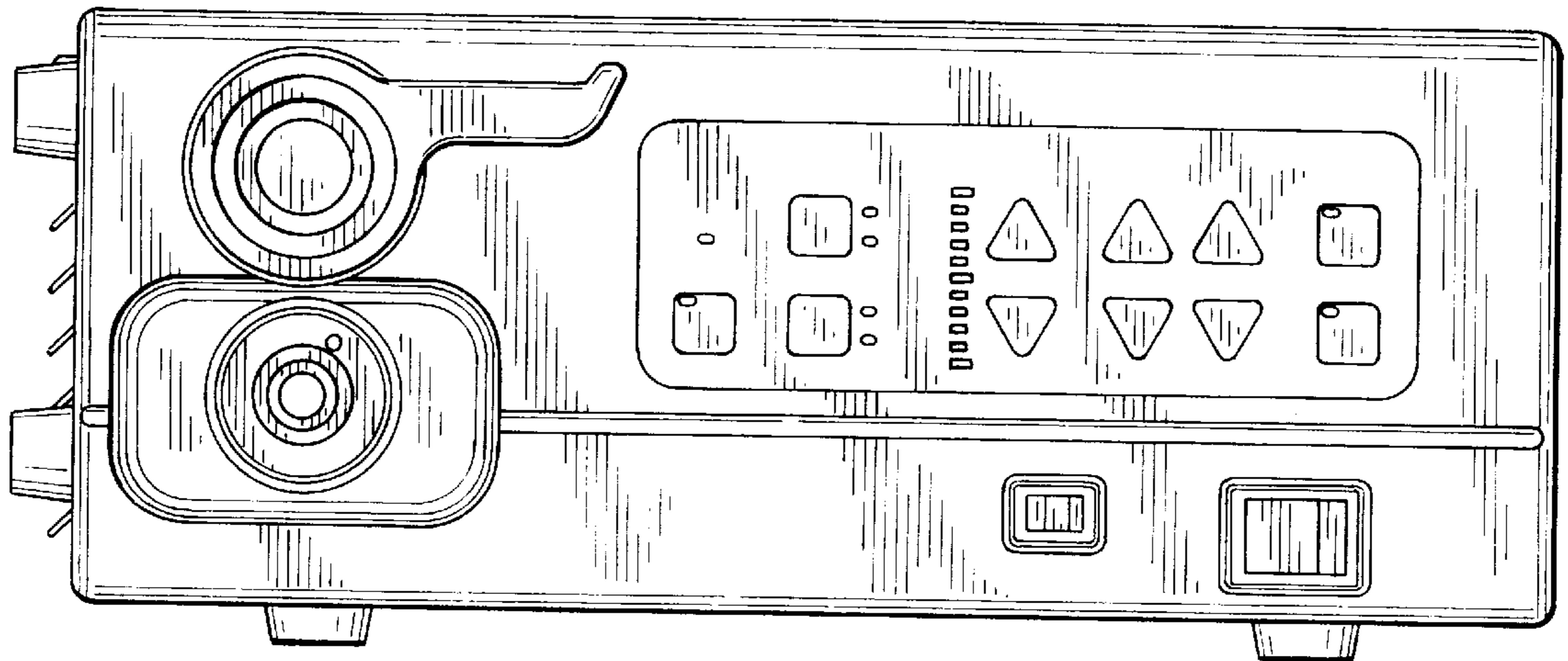


FIG. 3

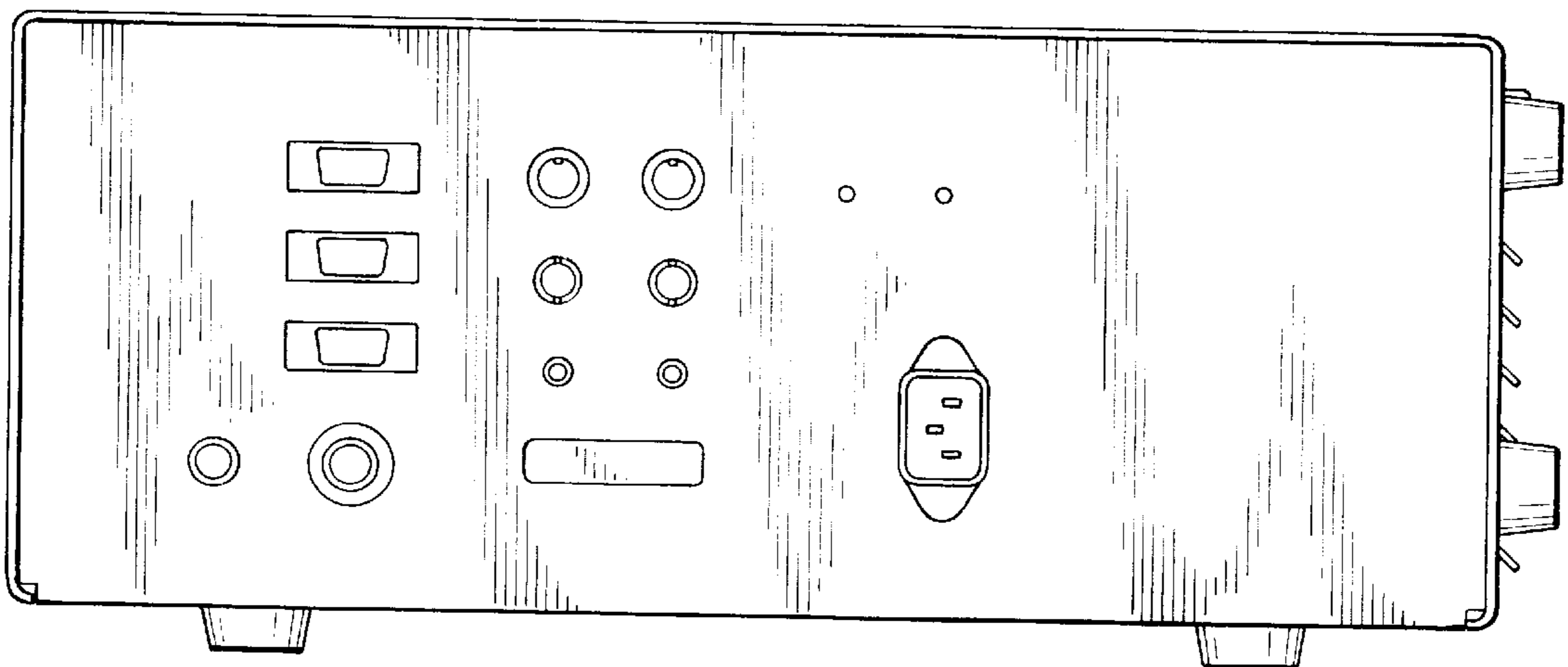


FIG. 4

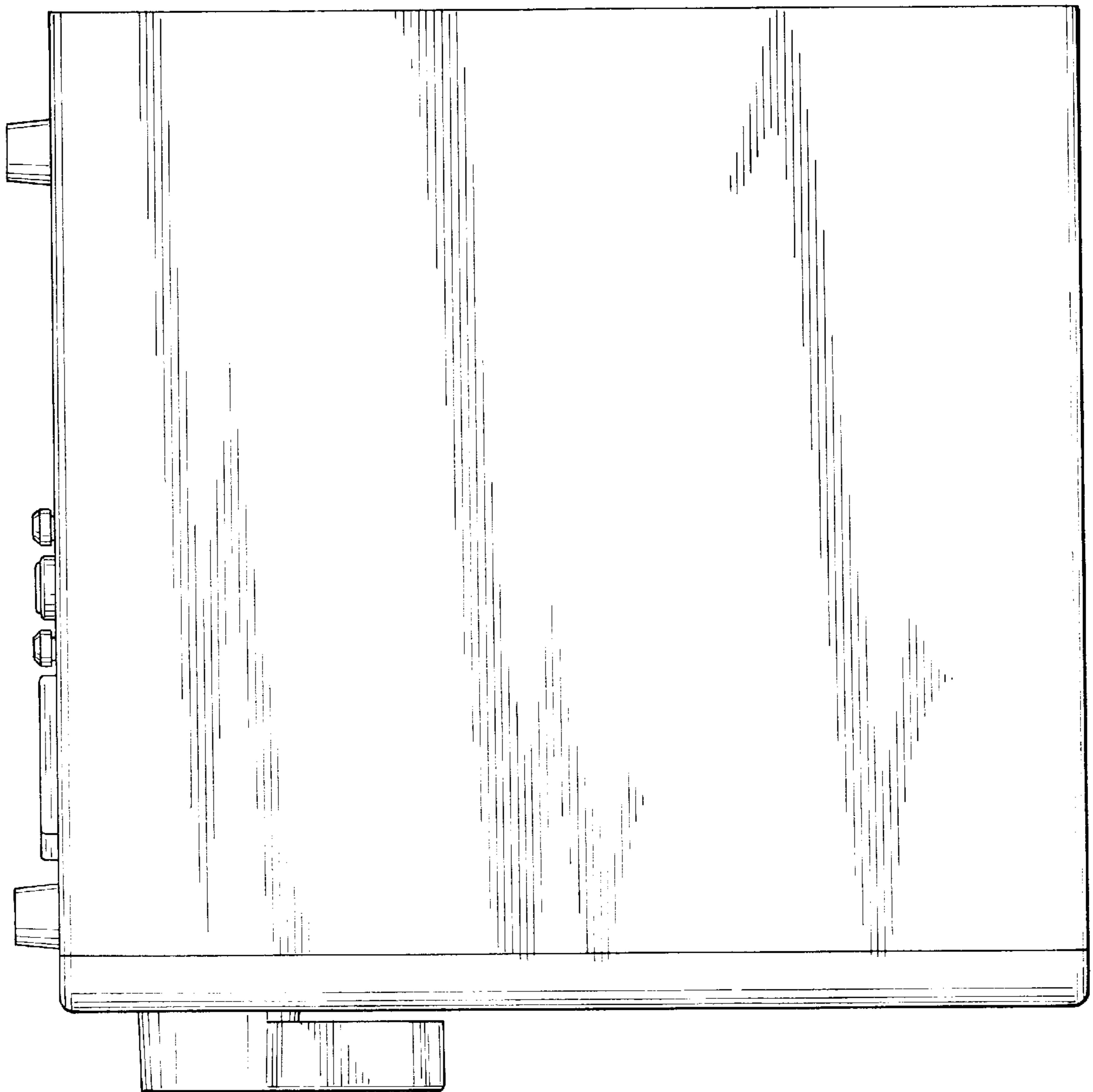




FIG. 5

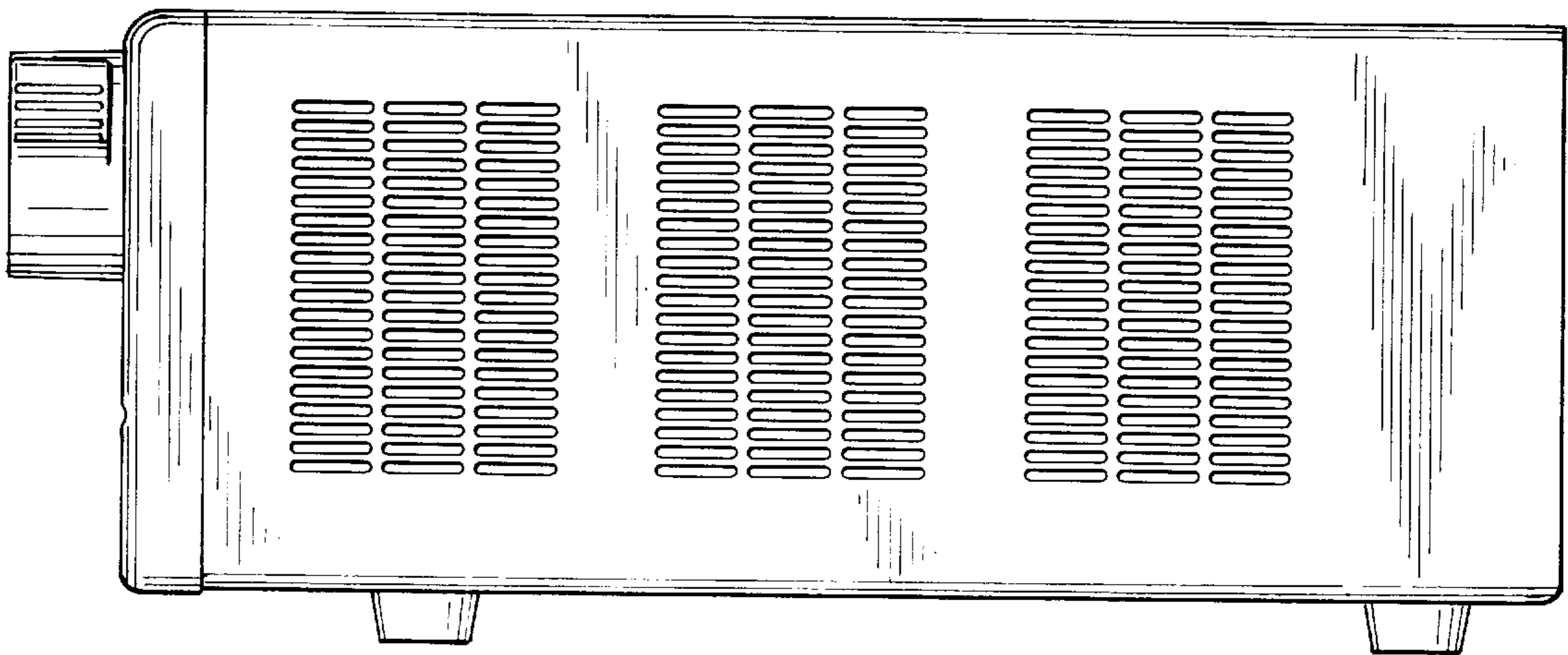


FIG. 6

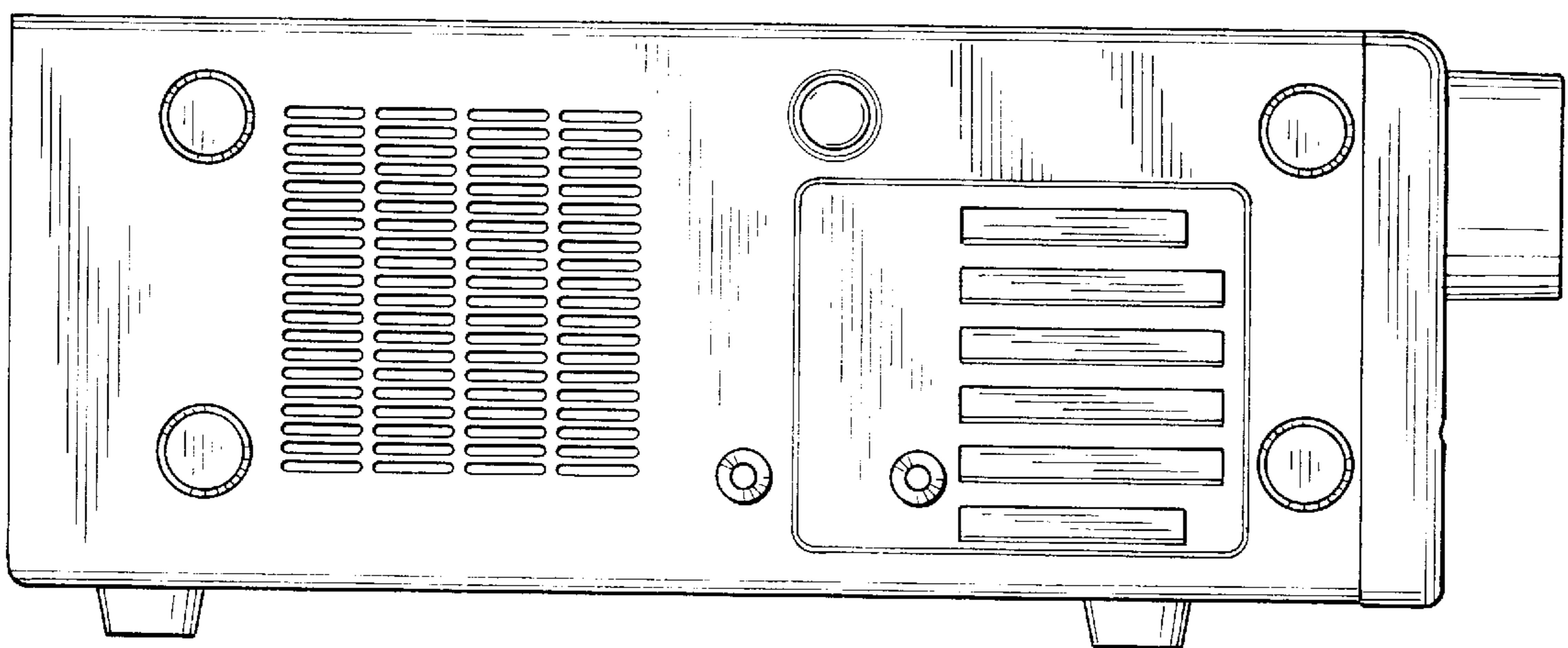


FIG. 7

